

30V N-Channel Enhancement Mode Power MOSFET

Description

WMQ40N03T1 uses advanced power trench technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Features

• $V_{DS} = 30V, I_D = 40A$

 $R_{DS(on)}$ < 5.5m Ω @ V_{GS} = 10V

 $R_{DS(on)} < 9.0 m\Omega$ @ $V_{GS} = 4.5 V$

- Green Device Available
- Low Gate Charge
- Advanced High Cell Density Trench Technology
- 100% EAS Guaranteed



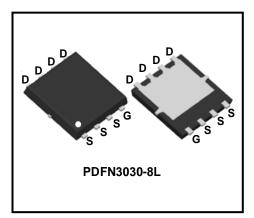
- Power Management Switches
- DC/DC Converter

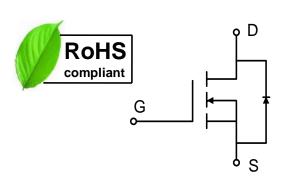
Absolute Maximum Ratings

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V _{DS}	30	V
Gate-Source Voltage		V _{GS}	±20	V
Continuous Drain Current@10V¹	T _C =25°C	l _D	40	A
	T _C =100°C		20	
	T _A =25°C		15	
	T _A =70°C		12	
Pulsed Drain Current ²	1	I _{DM}	140	Α
Single Pulse Avalanche Energy ³		EAS	101.2	mJ
Avalanche Current		las	45	Α
Total Power Dissipation ⁴	T _C =25°C	- P _D	59	W
	T _A =25°C		2	
Operating Junction and Storage Temperature Range		TJ, TSTG	-55 to+150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ¹	R ₀ JA	62	°C/W
Thermal Resistance from Junction-to-Case ¹	R _θ Jc	2.1	°C/W







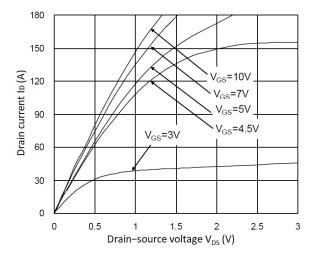
Electrical Characteristics T_c = 25°C, unless otherwise noted

Parameter		Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static Characteristics		1			l .	l .	
Drain-Source Breakdown Voltage		V _{(BR)DSS}	$V_{GS} = 0V, I_D = 250\mu A$	30	-	-	V
Gate-body Leakage current		I _{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
Zero Gate Voltage Drain Current	T _J =25°C	- I _{DSS}	V _{DS} = 24V, V _{GS} = 0V	-	-	1	μА
	T _J =55°C			-	-	5	
Gate-Threshold Voltage	Gate-Threshold Voltage		$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2	-	2.5	V
			V _{GS} = 10V, I _D = 20A	-	4.8	5.5	
Drain-Source On-Resistance	ce²	R _{DS(on)}	V _{GS} = 4.5V, I _D = 10A	-	6.5	9	mΩ
Forward Transconductance	;	g fs	V _{DS} =5V , I _D =30A	-	43	-	S
Dynamic Characteristics							
Input Capacitance		C _{iss}		-	1895	-	
Output Capacitance	utput Capacitance C		$V_{DS} = 15V, V_{GS} = 0V, f = 1MHz$	-	267	-	pF
Reverse Transfer Capacita	nce	C _{rss}		-	192	-	
Switching Characterist	ics		L		ı	ı	
Gate Resistance		R_g	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	-	2.0	-	Ω
Total Gate Charge		\mathbf{Q}_{g}		-	20	-	
Gate-Source Charge		Q _{gs}	$V_{GS} = 4.5V, V_{DS} = 15V, I_{D} = 15A$	-	7.6	-	nC
Gate-Drain Charge		Q_{gd}	. 10/1	-	7.2	-	<u> </u>
Turn-On Delay Time		t _{d(on)}		-	7.8	-	
Rise Time		tr	$V_{GS} = 10V, V_{DD} = 15V,$	-	15	-	nS
Turn-Off Delay Time		t _{d(off)}	$R_G = 3.3\Omega$, $I_D = 15A$	-	37.3	-	
Fall Time		t _f		-	10.6	-	
Drain-Source Body Dio	de Charac	teristics		•			
Diode Forward Voltage ²		V _{SD}	I _S = 1A, V _{GS} = 0V	-	-	1	V
Continuous Source Current	1,5	Is	V _G =V _D =0V , Force Current	-	-	40	Α
Body Diode Reverse Recov	ery Time	t _{rr}		-	14	-	nS
Body Diode Reverse Recov Charge	/ery	Qrr	I _F = 20A, dI/dt = 100A/μs	-	5	-	nC

Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\, \leqslant \, 300 \text{us}$, duty cycle $\, \leqslant \! 2\%$
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS} =45A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.





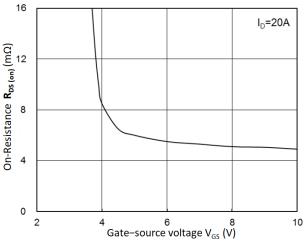
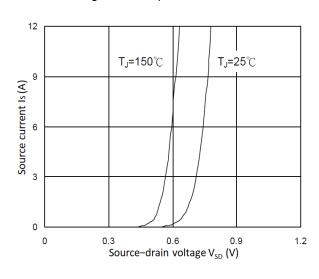


Figure 1. Output Characteristics

Figure 2. R_{DS}(on) vs. V_{GS}



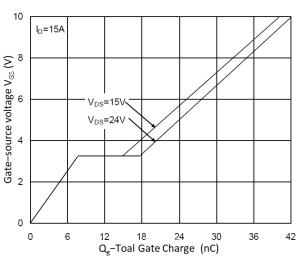
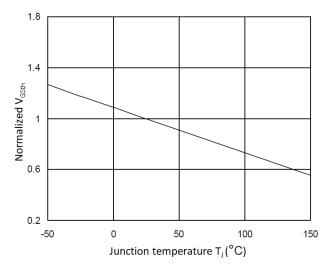


Figure 3. Forward Characteristics of Reverse

Figure 4. Gate Charge Characteristics



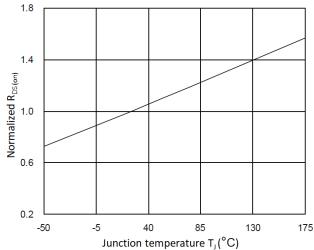


Figure 5. Normalized V_{GSth} vs. T_J

Figure 6. Normalized R_{DS(on)} vs. T_J



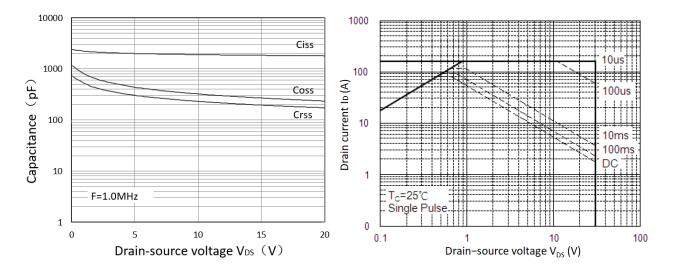


Figure 7. Capacitance Characteristics

Figure 8. Safe Operating Area

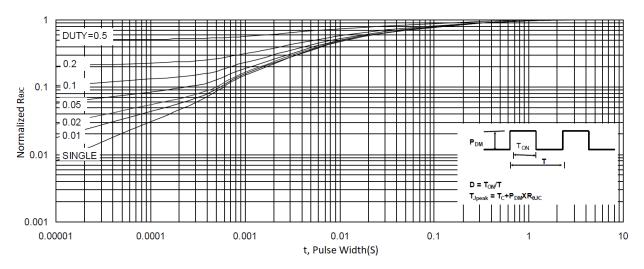


Figure 9. Normalized Maximum Transient Thermal Impedance

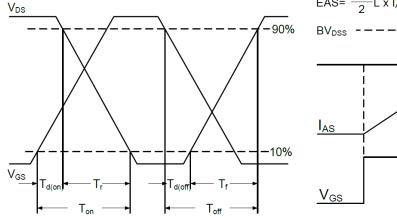


Figure 10. Switching Time Waveform

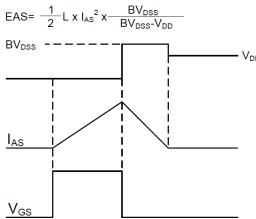
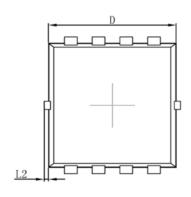


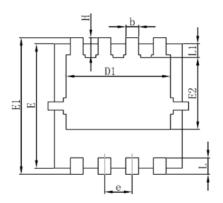
Figure 11. Unclamped Inductive Switching

Waveform



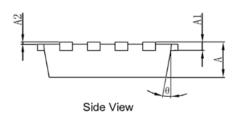
Mechanical Dimensions for PDFN3030-8L





Top View

Bottom View



COMMON DIMENSIONS

	MM			
SYMBOL	MIN	MAX		
А	0.70	0.90		
A1	0.150REF			
A2	0	0.05		
D	2.90	3.25		
D1	2.25	2.65		
E	2.90	3.20		
E1	3.10	3.45		
E2	1.54	1.94		
b	0.20	0.40		
е	0.60	0.70		
L	0.30	0.50		
L1	0.22	0.45		
L2	0	0.13		
Н	0.20	0.65		
θ	0°	14°		



Ordering Information

Part	Package	Marking	Packing method
WMQ40N03T1	PDFN3030-8L	B3006	Tape and Reel

Marking Information



B3006 = Device code YWWXXX= Date code

Contact Information

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